

• General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. It is suitable for automotive application.

• Features

- AEC-Q101 Qualified
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

• Application

- BLDC Motor driver
- DC-DC
- Load Switch

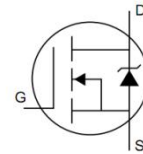
• Ordering Information:

Part NO.	ZMSA420N10D
Marking	ZMS420N10
Packing Information	REEL TAPE
Basic ordering unit (pcs)	2500

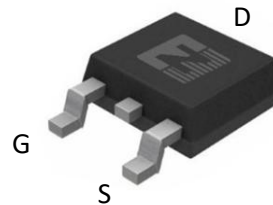
• Absolute Maximum Ratings ($T_C=25^\circ\text{C}$)

Parameter	Symbol	Conditions	Value	Unit
Drain-Source Voltage	V_{DS}		100	V
Gate-Source Voltage ^①	V_{GS}		±20	V
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	20	A
	I_D	$T_C=75^\circ\text{C}$	17	A
	I_D	$T_C=100^\circ\text{C}$	15	A
Pulsed Drain Current	I_{DM}	Pulsed; $t_p \leq 10 \mu\text{s}$; $T_{mb} = 25^\circ\text{C}$;	60	A
Total Power Dissipation	P_D	$T_C=25^\circ\text{C}$	50	W
Total Power Dissipation	P_D	$T_A=25^\circ\text{C}$	2.4	W
Operating Junction Temperature	T_J		-55 to +175	°C
Storage Temperature	T_{STG}		-55 to +175	°C
Single Pulse Avalanche Energy	E_{AS}	$L=0.1\text{mH}$, $V_{GS}=10\text{V}$, $R_g=25\Omega$,	10	mJ
		$L=0.5\text{mH}$, $V_{GS}=10\text{V}$, $R_g=25\Omega$,	21	mJ
ESD Level (HBM)	CLASS 1B			

• Product Summary



$V_{DS} = 100\text{V}$
 $R_{DS(ON)} = 50\text{m}\Omega$
 $I_D = 20\text{A}$



TO-252



•Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}		-	3	$^{\circ}C/W$
Thermal resistance, junction-ambient ^②	R_{thJA}		-	62	$^{\circ}C/W$
Soldering temperature (total time<10s)	T_{sold}		-	260	$^{\circ}C$

•Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.3	1.8	2.5	V
Drain-Source Leakage Current	I_{DSS}	$V_{GS}=0V, V_{DS}=100V$			1.0	μA
Gate- Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=10A$		50	65	m Ω
		$V_{GS}=4.5V, I_D=6A$		64	83	m Ω
Forward Transconductance	g_{FS}	$V_{DS}=5V, I_{SD}=10A$		4		S
Diode Forward Voltage	V_{FSD}	$V_{GS}=0V, I_{SD}=10A$			1.3	V

•Dynamic characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	
Input capacitance	C_{iss}	$f=1MHz, V_{DS}=25V$	-	275	-	pF	
Output capacitance	C_{oss}		-	146	-		
Reverse transfer capacitance	C_{rss}		-	3.7	-		
Gate Resistance	R_g	$f=1MHz$	-	1.3		Ω	
Total gate charge	Q_g	$V_{DD}=15V, I_D=10A, V_{GS}=10V$	-	7	-	nC	
	$Q_g(4.5v)$		-	4	-		
	Gate - Source charge		Q_{gs}	-	2.1		-
	Gate - Drain charge		Q_{gd}	-	1.1		-
Turn-ON Delay time	$t_{D(on)}$	$V_{GS}=10V, V_{DS}=15V, R_G=3.3\Omega, I_D=10A$	-	10	-	ns	
Turn-ON Rise time	t_r		-	4.2	-	ns	
Turn-Off Delay time	$t_{D(off)}$		-	15	-	ns	
Turn-Off Fall time	t_f		-	4.4	-	ns	
Reverse Recovery Time	t_{RR}	$V_{DD}=20V, di_S/dt=100A/\mu s, I_S=10A$	-	57	-	ns	
Reverse Recovery Charge	Q_{RR}		-	80	-	nC	

Fig.1 Gate-Charge Characteristics

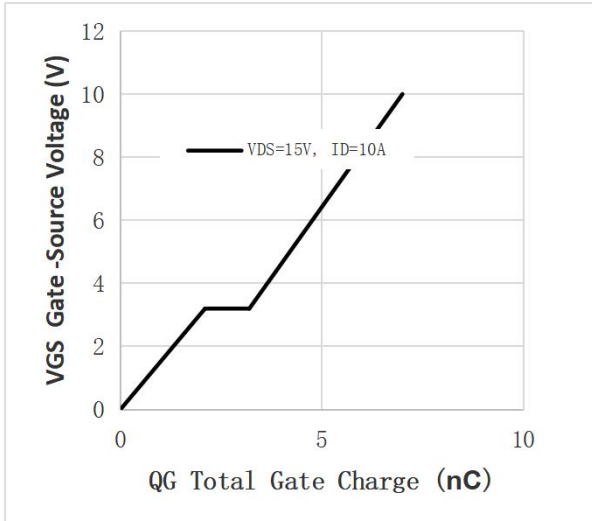


Fig.2 Capacitance Characteristics

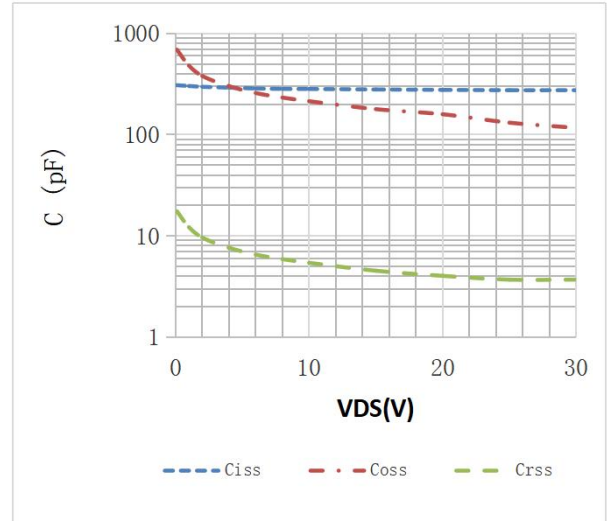


Fig.3 Power Dissipation

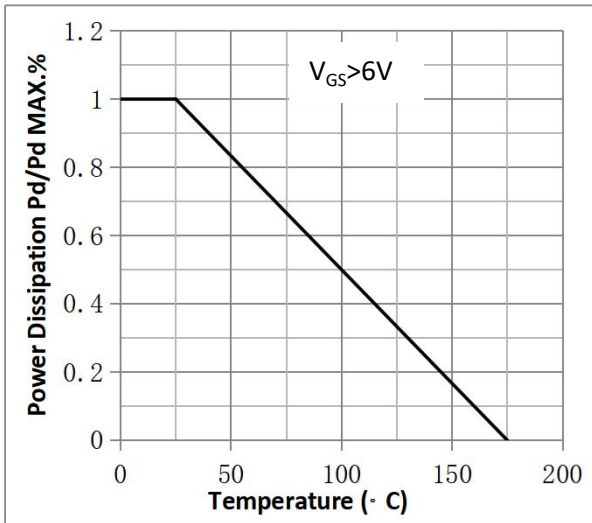


Fig.4 Typical output Characteristics

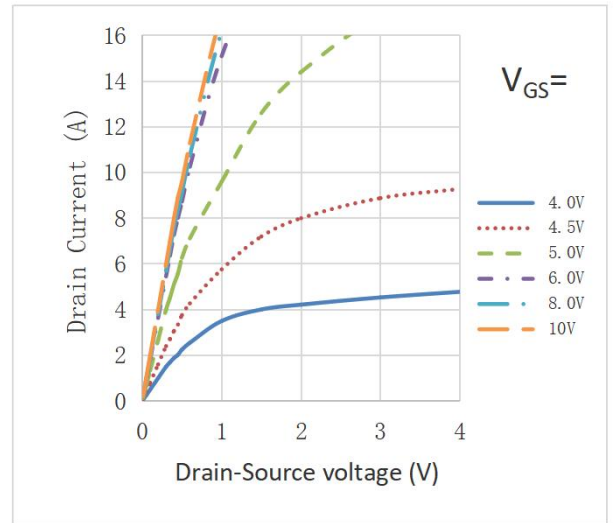


Fig.5 Threshold Voltage V.S Junction Temperature

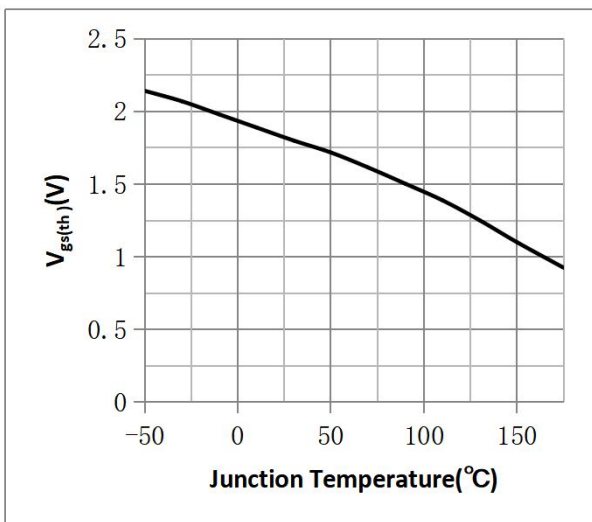


Fig.6 Resistance V.S Drain Current

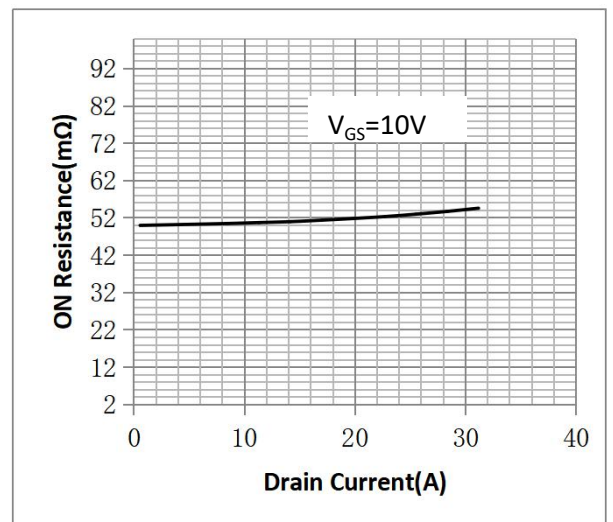


Fig.7 On-Resistance VS Gate Source Voltage

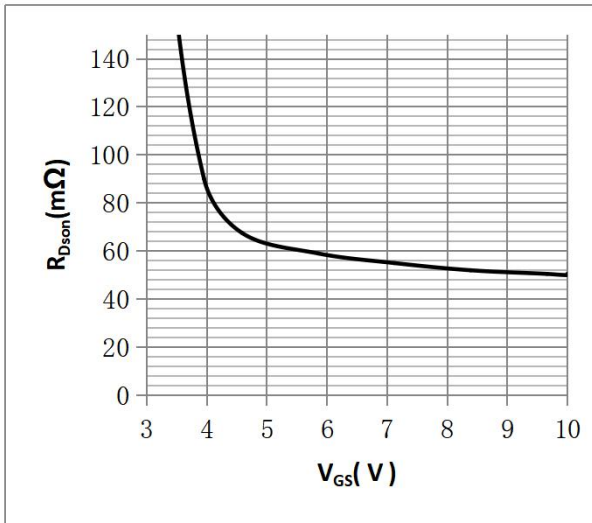


Fig.8 On-Resistance V.S Junction Temperature

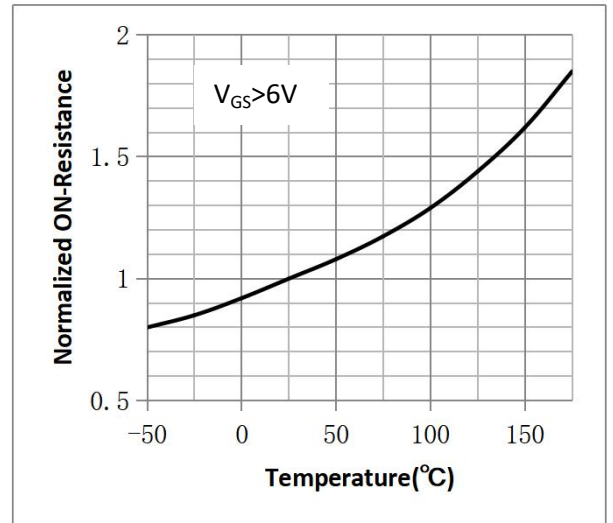


Figure 9. Diode Forward Voltage vs. Current

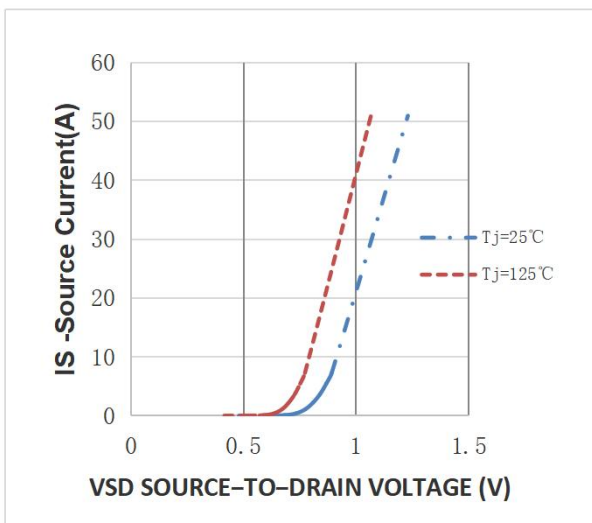


Figure 10. Transfer Characteristics

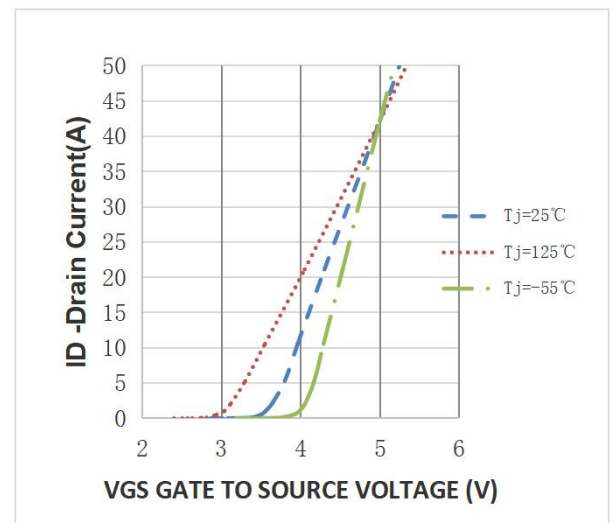


Fig.11 Safe Operating Area

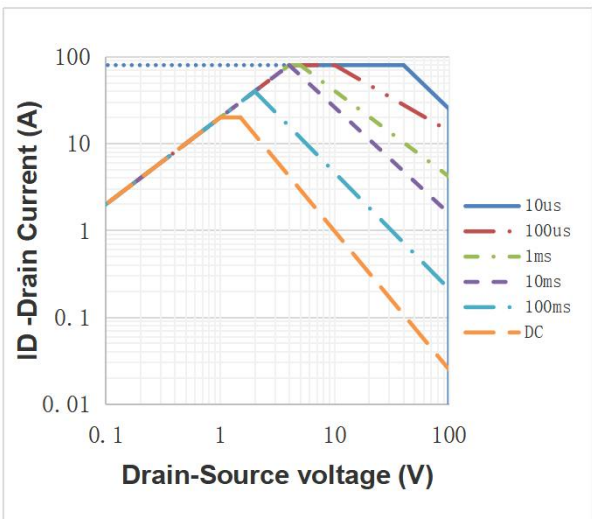
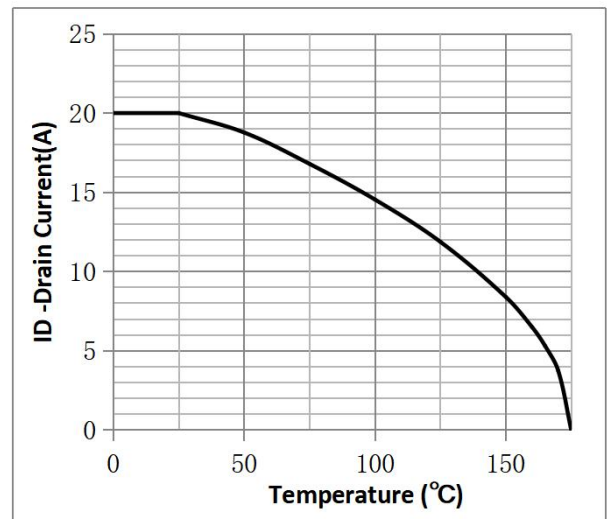
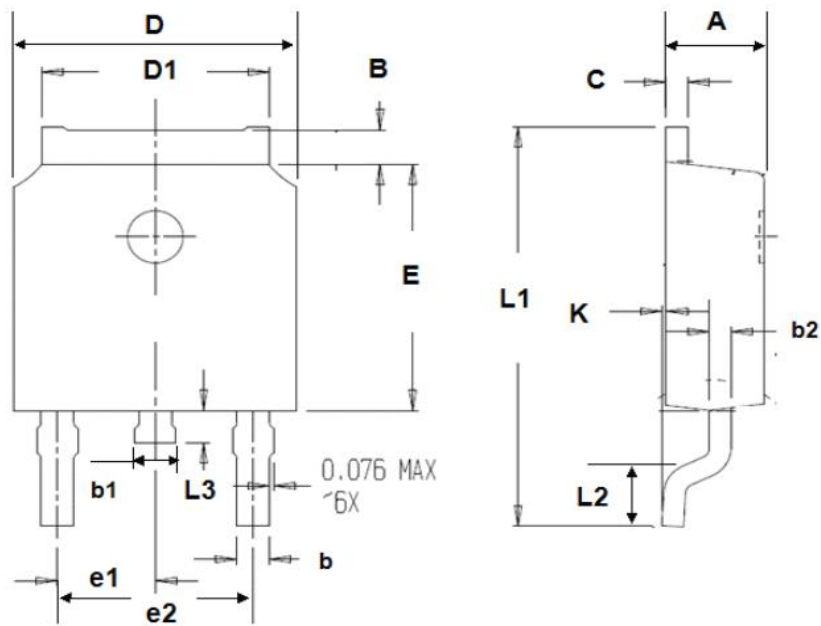


Fig.12 ID vs. Case Temperature^③



•TO-252 Package Outline

SYMBOL	min	max	SYMBOL	min	max
A	2.10	2.50	B	0.85	1.25
b	0.50	0.90	b1	0.50	0.90
b2	0.45	0.70	C	0.45	0.70
D	6.30	6.75	D1	5.10	5.50
E	5.30	6.30	e1	2.24	2.35
L1	9.20	10.60	e2	4.43	4.75
L2	0.90	1.75	L3	0.60	1.10
K	0.00	0.23			



Note:

- ① Pulse : $V_{GS}=+20V/-20V$, Duty cycle=50%, $T_j=175^{\circ}C$, $t=1000$ hours; For DC , the following test conditions can be passed: $V_{GS}=+20V/-10V$, $T_j=175^{\circ}C$, $t=1000$ hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature. $V_{GS}=10V$.

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Revision History

Version	Date	Change
A	2021.12.10	
B	2022.10.20	modify 3.Add It is suitable for automotive application.4.Add Dynamic
C	2023.12.28	Correct marking